## Features

- Compliant with ETSI 300744 DVB-T, Unified Nordig and DTG performance specifications
- Diversity enabled multi-tuner solution.
- High performance with fast fully blind acquisition and tracking capability
- Low power consumption: less than 0.32 W , and eco-friendly standby and sleep modes
- Single 8 MHz SAW filter for $6,7 \& 8 \mathrm{MHz}$ OFDM
- Superior single frequency network performance
- Fast AGC to track out signal fades
- Advanced Doppler tracking capability
- Enhanced frequency capture range to include triple offsets
- External 4 MHz clock or single low-cost 20.48 MHz crystal, tolerance up to $+/-200 \mathrm{ppm}$
- Automatic mode ( $2 \mathrm{~K} / 8 \mathrm{~K}$ ), guard and spectral inversion detection
- Very low driver software overhead due to on-chip state-machine control
- Novel RF level detect facility via a separate ADC
- Pre and post Viterbi-decoder bit error rates, and uncorrectable block count

September 2005

## Ordering Information

| ZL10354QCG | 64 Pin LQFP | Trays, Bake \& Drypack |
| :--- | :--- | :--- |
| ZL10354QCG1 | 64 Pin LQFP* | Trays, Bake \& Drypack |
| ZL10354QCF | 64 Pin LQFP | Trays, Bake \& Drypack |
| ZL10354QCF1 | 64 Pin LQFP* | Trays, Bake \& Drypack |
|  | ${ }^{*} P b$ Free Matte Tin |  |
|  | $\mathbf{- 4 0} \mathbf{C}$ to $\mathbf{+ 8 5}^{\mathbf{\circ}} \mathbf{C}$ |  |

## Applications

- Digital terrestrial set-top boxes
- Integrated digital televisions
- Personal video recorders
- PC-TV receivers
- Portable applications


## Description

The ZL10354 is a superior fourth generation fully compliant ETSI ETS300 744 COFDM demodulator that exceeds, with margin, the performance requirements of all known DVB-T digital terrestrial television standards, including Unified Nordig and DTG.


Figure 1 - Block Diagram

A high performance 10 bit on-chip ADC is used to sample the 44 or 36 MHz IF analog signal. Advanced digital filtering of the upper and lower channel enables a single 8 MHz channel SAW filter to be used for $6,7 \mathrm{and} 8 \mathrm{MHz}$ OFDM signal reception. All sampling and other internal clocks are derived from a single 20.48 MHz crystal or a 4 MHz clock input, the tolerance of which may be relaxed as much as 200 ppm .

The pinout of the ZL10354 is highly adaptable to allow multiple devices to be connected as a diversity receiver. Any number of ZL10354s can be connected together using the high-speed five-bit diversity data bus in a chain of devices.

Together with separate aerials and tuners for each device, the combined performance of the connected demodulators will normally exceed a single device, especially in mobile applications or in areas where the signal is prone to echoes and/or fading.

The ZL10354 has a wide frequency capture range able to automatically compensate for the combined offset introduced by the tuner xtal and broadcaster triple frequency offsets.

An on-chip state machine controls all acquisition and tracking operations of the ZL10354 as well as controlling the tuner via a 2 -wire bus. Any frequency range can be automatically scanned for digital TV channels. This mechanism ensures minimal interaction, maximum flexibility and fast acquisition - very low software overhead.

Also included in the design is a 7-bit ADC to detect the RF signal strength and thereby efficiently control the tuner RF AGC.

Users have access to all the relevant signal quality information, including input signal power level, signal-to-noise ratio, pre-Viterbi BER, post-Viterbi BER, and the uncorrectable block counts. The error rate monitoring periods are programmable over a wide range.

The device is packaged in a $7 \times 7 \mathrm{~mm}$ 64-pin LQFP and is very low power.

## Table of Contents

1.0 Pin \& Package Details ..... 7
1.1 Pin Outline ..... 7
1.2 Pin Allocation ..... 8
1.3 Pin Description ..... 9
2.0 Functional Description ..... 11
2.1 Analog-to-Digital Converter ..... 12
2.2 Automatic Gain Control ..... 12
2.3 IF to Baseband Conversion ..... 13
2.4 Adjacent Channel Filtering ..... 13
2.5 Interpolation and Clock Synchronization ..... 13
2.6 Carrier Frequency Synchronization ..... 13
2.7 Symbol Timing Synchronization ..... 13
2.8 Fast Fourier Transform ..... 13
2.9 Common Phase Error Correction ..... 14
2.10 Channel Equalization. ..... 14
2.11 Impulse Filtering ..... 14
2.12 Transmission Parameter Signalling (TPS) ..... 14
2.13 Diversity Optimizer ..... 14
2.14 De-Mapper. ..... 14
2.15 Symbol and Bit De-Interleaving ..... 14
2.16 Viterbi Decoder ..... 15
2.17 MPEG Frame Aligner ..... 15
2.18 De-interleaver ..... 15
2.19 Reed-Solomon Decoder ..... 15
2.20 De-scrambler ..... 15
2.21 MPEG Transport Interface ..... 15
3.0 Diversity Operation of ZL10354 ..... 16
3.1 Pin Allocation ..... 17
4.0 Interfaces ..... 21
4.1 2-Wire Bus ..... 21
4.1.1 Host ..... 21
4.1.2 Tuner ..... 21
4.1.3 Examples of 2-Wire Bus Messages ..... 22
4.1.4 Primary 2-Wire Bus Timing ..... 22
4.2 Diversity Bus ..... 23
4.3 MPEG ..... 24
4.3.1 Data Output Header Format. ..... 24
4.3.2 MPEG Data Output Signals ..... 25
4.3.3 MPEG Output Timing ..... 25
4.3.4 MOCLKINV = 1 ..... 26
4.3.5 MOCLKINV = 0 ..... 26
5.0 Electrical Characteristics ..... 27
5.1 Recommended Operating Conditions ..... 27
5.2 Absolute Maximum Ratings. ..... 27
5.3 DC Electrical Characteristics ..... 28
5.4 Crystal Specification and External Clocking ..... 28
5.4.1 Selection of External Components ..... 29
5.4.1.1 Loop Gain Equation ..... 29
5.4.1.2 List of Equation Parameters ..... 29
5.4.1.3 Calculating Crystal Power Dissipation ..... 30
5.4.1.4 Capacitor Values ..... 30
5.4.1.5 Oscillator/Clock Application Notes ..... 31

## Table of Contents

6.0 Application Circuit.32

## List of Figures

Figure 1 - Block Diagram ..... 1
Figure 2 - Pin Outline ..... 7
Figure 3 - OFDM Demodulator Diagram ..... 11
Figure 4 - FEC Block Diagram ..... 12
Figure 5 - Outline Diversity System ..... 16
Figure 6 - Outline of Dual Diversity/Play-and-Record System ..... 17
Figure 7 - Basic Interconnections and Serial Address Options for Four ZL10354s on the Same Bus. ..... 20
Figure 8 - Primary 2-Wire Bus Timing ..... 22
Figure 9 - Timing Diagram for the Diversity Bus with DvrClkInv = 1 ..... 23
Figure 10 - DVB Transport Packet Header Byte ..... 24
Figure 11 - MPEG Output Data Waveforms ..... 25
Figure 12 - MPEG Timing - MOCLKINV = 1 ..... 26
Figure 13 - MPEG Timing - MOCLKINV = 0 ..... 26
Figure 14-Crystal Oscillator Circuit ..... 29
Figure 15 - External Clocking via AC Coupling ..... 31
Figure 16 - Typical Application Circuit ..... 32

## List of Tables

Table 1 - Pin Names - numeric. ..... 8
Table 2 - Pin Names - alphabetical order. .....  8
Table 3 - Pin Names Mode A - diversity first or last device in chain. ..... 17
Table 4 - Pin Names Mode B-diversity mid-chain device. ..... 18
Table 5 - Pin Names Mode C - non-diversity use ..... 18
Table 6 - Diversity Pin Configurations ..... 19
Table 7 - Timing of 2-Wire Bus ..... 23
Table 8 - Diversity Bus Timing ..... 24

### 1.0 Pin \& Package Details

### 1.1 Pin Outline

Figure 2 below shows the basic, non-diversity, pin functions of the ZL10354. The device can effectively be set up in seven different pin configurations, so for brevity only this version is shown.


Figure 2 - Pin Outline

### 1.2 Pin Allocation

| Pin | Function | Pin | Function | Pin | Function | Pin | Function |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Vss | 17 | SADD1 | 33 | Vdd | 49 | $\begin{aligned} & \text { MDO0/Dv0/ } \\ & \text { Dv1 } \end{aligned}$ |
| 2 | Vdd | 18 | SADD0 | 34 | RFLEV | 50 | $\begin{aligned} & \text { MDO1/Dv1/ } \\ & \text { Dv3 } \end{aligned}$ |
| 3 | Vss | 19 | CVdd | 35 | CLK2/GPP0 | 51 | MDO2/Dv2 |
| 4 | CLK1 | 20 | Vss | 36 | DATA2/GPP1 | 52 | $\begin{aligned} & \text { MDO3/Dv3/ } \\ & \text { Dv1 } \end{aligned}$ |
| 5 | DATA1 | 21 | PLLVdd | 37 | CVdd | 53 | $\begin{aligned} & \text { MDO4/Dv4/ } \\ & \text { Dv0 } \end{aligned}$ |
| 6 | $\overline{\mathrm{IRQ}} / \mathrm{Dv} 4 / \mathrm{Dv} 0$ | 22 | PLLGND | 38 | Vss | 54 | Vdd |
| 7 | CVdd | 23 | $\overline{\mathrm{XTI}}$ | 39 | CVdd | 55 | Vss |
| 8 | Vss | 24 | XTO | 40 | Vss | 56 | MDO5 |
| 9 | RESET | 25 | Vss | 41 | AGC2/GPP2/DvVal | 57 | MDO6 |
| 10 | SLEEP | 26 | PLLTEST | 42 | AGC1 | 58 | MDO7 |
| 11 | STATUS/Dv3/ Dv1 | 27 | OSCMODE | 43 | GPP3/DvCIk | 59 | CVdd |
| 12 | N/C | 28 | AVdd | 44 | SMTEST | 60 | Vss |
| 13 | Vdd | 29 | AGnd | 45 | Vdd | 61 | MOCLK/DvClk |
| 14 | Vss | 30 | VIN | 46 | Vss | 62 | $\overline{\text { BKERR }}$ |
| 15 | N/C | 31 | $\overline{\mathrm{VIN}}$ | 47 | MOSTRT | 63 | MICLK |
| 16 | N/C | 32 | AGnd | 48 | MOVAL/DvVal | 64 | CVdd |

Table 1 - Pin Names - numeric

| Function | Pin | Function | Pin | Function | Pin | Function | Pin |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| AGC1 | 42 | GPP3/DvClk | 43 | PLLTEST | 26 | Vdd | 54 |
| AGC2/GPP2/DvVal | 41 | $\overline{\text { IRQ/Dv4/Dv0 }}$ | 6 | PLLVdd | 21 | VIN | 30 |
| AGnd | 29 | MDO0/Dv0/ Dv1 | 49 | $\overline{\text { RESET }}$ | 9 | $\overline{\text { VIN }}$ | 31 |
| AGnd | 32 | MDO1/Dv1/ Dv3 | 50 | RFLEV | 34 | Vss | 1 |
| AVdd | 28 | MDO2/Dv2 | 51 | SADD0 | 18 | Vss | 3 |
| $\overline{\text { BKERR }}$ | 62 | MDO3/Dv3/ Dv1 | 52 | SADD1 | 17 | Vss | 8 |
| CLK1 | 4 | MDO4/Dv4/ Dv0 | 53 | N/C/Dv0/Dv1 | 16 | Vss | 14 |
| CLK2/GPP0 | 35 | MDO5 | 56 | N/C/Dv1/Dv3 | 15 | Vss | 20 |
| CVdd | 7 | MDO6 | 57 | N/C/Dv2 | 12 | Vss | 25 |
| CVdd | 19 | MDO7 | 58 | SLEEP | 10 | Vss | 38 |

Table 2 - Pin Names - alphabetical order

| CVdd | 37 | MICLK | 63 | SMTEST | 44 | Vss | 40 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| CVdd | 39 | MOCLK/DvClk | 61 | STATUS/Dv3/ <br> Dv1 | 11 | Vss | 46 |
| CVdd | 59 | MOSTRT | 47 | Vdd | 2 | Vss | 55 |
| CVdd | 64 | MOVAL/DvVal | 48 | Vdd | 13 | Vss | 60 |
| DATA1 | 5 | OSCMODE | 27 | Vdd | 33 | $\overline{\text { XTI }}$ | 23 |
| DATA2/GPP1 | 36 | PLLGND | 22 | Vdd | 45 | XTO | 24 |

Table 2 - Pin Names - alphabetical order (continued)

### 1.3 Pin Description

## Pin Description Table

| Pin No | Name | Pin Description | I/O | Type | V | mA |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MPEG pins |  |  |  |  |  |  |
| 47 | MOSTRT | MPEG packet start | O | CMOS Tristate | 3.3 | 1 |
| 48 | MOVAL (or DvVal-O) | MPEG/diversity data valid | 0 |  | 3.3 | 1 |
| $\begin{aligned} & 49-53, \\ & 56-58 \end{aligned}$ | $\begin{aligned} & \mathrm{MDO}(0: 4) / \mathrm{Dv}(0: 4)-\mathrm{O} \\ & \mathrm{MDO}(5: 7) \end{aligned}$ | MPEG/diversity data bus | O |  | 3.3 | 1 |
| 61 | MOCLK (or DvCIk-O) | MPEG/diversity clock out | 0 |  | 3.3 | 1 |
| 62 | $\overline{\text { BKERR }}$ | Block error | O |  | 3.3 | 1 |
| 63 | MICLK | MPEG clock in | I | CMOS | 3.3 |  |
| 11 | STATUS (or Dv3/1) | Status output or diversity data | I/O |  | 3.3 | 1 |
| 6 | $\overline{\mathrm{IRQ}}$ (or Dv4/0) | Interrupt output or diversity data | I/O | Open drain | 5 | 6 |
| Control pins |  |  |  |  |  |  |
| 4 | CLK1 | Serial clock | I | CMOS | 5 |  |
| 5 | DATA1 | Serial data | I/O | Open drain | 5 | 6 |
| 23 | $\overline{\mathrm{XTI}}$ | Low phase noise oscillator | 1 | CMOS |  |  |
| 24 | XTO |  | 0 |  |  |  |
| 10 | SLEEP | Device power down | I |  | 3.3 |  |
| 12, 15, 16 | N/C | N/C or Diversity data | I/O |  | 3.3 |  |
|  | Dv2,1,0/2,3,4 |  | I/O |  | 3.3 |  |
| 17, 18 | SADD(1:0) | Serial address set | 1 |  | 3.3 |  |
| 44 | SMTEST | Production test (only set low) | I |  | 3.3 |  |

Pin Description Table (continued)

| Pin No | Name | Pin Description | I/O | Type | V | mA |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 35 | CLK2/GPP0 | Serial clock tuner | I/O | Open drain | 5 | 6 |
| 36 | DATA2/GPP1 | Serial data tuner | I/O |  | 5 | 6 |
| 42 | AGC1 | Primary AGC | O |  | 5 | 6 |
| 41 | AGC2/GPP2 | Secondary AGC | I/O |  | 5 | 6 |
| 43 | GPP(3) | General purpose I/O | I/O |  | 5 | 6 |
| 9 | $\overline{\text { RESET }}$ | Device reset | I | CMOS | 5 |  |
| 27 | OSCMODE | Crystal oscillator mode | I | CMOS | 3.3 |  |
| 26 | PLLTEST | PLL analog test | O | (tristated) |  |  |
| Analog inputs |  |  |  |  |  |  |
| 30 | VIN | positive input | I |  |  |  |
| 31 | $\overline{\mathrm{VIN}}$ | negative input | 1 |  |  |  |
| 34 | RFLEV | RF level | I |  |  |  |
| Supply pins |  |  |  |  |  |  |
| 21 | PLLVdd | PLL supply | S |  | 1.8 |  |
| 22 | PLLGnd |  | S |  | 0 |  |
| 7, 19, 37, 39, 59, 64 | CVdd | Core logic power | S |  | 1.8 |  |
| 2, 13, 45, 54, | Vdd | I/O ring power | S |  | 3.3 |  |
| $\begin{aligned} & 1,3,8,14,20,25, \\ & 38,40,46,55,60 \end{aligned}$ | Vss | Core and I/O ground | S |  | 0 |  |
| 28 | AVdd | ADC analog supply | S |  | 1.8 |  |
| 29, 32 | AGnd |  | S |  | 0 |  |
| 33 | Vdd | 2nd ADC supply | S |  | 3.3 |  |

### 2.0 Functional Description

A functional block diagram of the ZL10354 OFDM demodulator is shown in Figure 3. This accepts an IF analog signal and delivers a stream of demodulated soft decision data to the on-chip Viterbi decoder. Clock, timing and frequency synchronization operations are all digital and there are no analog control loops except the AGC. The frequency capture range is large enough for all practical applications. This demodulator has novel algorithms to combat impulse noise as well as co-channel and adjacent channel interference. If the modulation is hierarchical, the OFDM outputs both high and low priority data streams. Only one of these streams is FEC-decoded, but the FEC can be switched from one stream to another with minimal interruption to the transport stream.


Figure 3 - OFDM Demodulator Diagram
The FEC module shown in Figure 4 consists of a concatenated convolutional (Viterbi) and Reed-Solomon decoder separated by a depth-12 convolutional de-interleaver. The Viterbi decoder operates on 5 -bit soft decisions to provide the best performance over a wide range of channel conditions. The trace-back depth of 128 ensures minimum loss of performance due to inevitable survivor truncation, especially at high code rates. Both the Viterbi and Reed-Solomon decoders are equipped with bit-error monitors. The former provides the bit error rate (BER) at the OFDM output. The latter is the more useful measure as it gives the Viterbi output BER. The error collecting intervals of these are programmable over a very wide range.


Figure 4 - FEC Block Diagram
The FSM controller shown in Figure 3 controls both the demodulator and the FEC. It also drives the 2 -wire bus to the tuner. The controller facilitates the automated search of all parameters or any sub-set of parameters of the received signal. It can also be used to scan any defined frequency range searching for OFDM channels. This mechanism provides the fast channel scan and acquisition performance, whilst requiring minimal software overhead in the host driver.

The algorithms and architectures used in the ZL10354 have been optimized to minimize power consumption.

### 2.1 Analog-to-Digital Converter

The ZL10354 has a high performance 10-bit analog-to-digital converter (ADC) which can sample a 6, 7 or 8 MHz bandwidth OFDM signal, with its spectrum centred at:

- 36.17 MHz IF
- 43.75 MHz IF
- 5-10 MHz near-zero IF

An on-chip programmable phase locked loop (PLL) is used to generate the ADC sampling clock. The PLL is highly programmable allowing a wide choice of sampling frequencies to suit any IF frequency, and all signal bandwidths.

### 2.2 Automatic Gain Control

An AGC module compares the absolute value of the digitized signal with a programmable reference. The error signal is filtered and is used to control the gain of the amplifier. A sigma-delta modulated output is provided, which has to be RC low-pass filtered to obtain the voltage to control the amplifier.

The programmable AGC reference has been optimized. A large value for the reference leads to excessive ADC clipping and a small value results in excessive quantization noise. Hence the optimum value has been determined assuming the input signal amplitude to be Gaussian distributed. The latter is justified by applying the central limit theorem in statistics to the OFDM signal, which consists of a large number of randomly modulated carriers. This reference or target value may have to be lowered slightly for some applications. Slope control bits have been provided for the AGCs and these have to be set correctly depending on the gain-versus-voltage slope of the gain control amplifiers.

The bandwidth of the AGC is set to a large value for quick acquisition then reduced to a small value for tracking. The AGC is free running during OFDM channel changes and locks to the new channel while the tuner lock is being established. This is one of the features of ZL10354 used to minimize acquisition time. A robust AGC lock mechanism is provided and the other parts of the ZL10354 begin to acquire only after the AGC has locked.

### 2.3 IF to Baseband Conversion

Sampling a 36.17 MHz IF signal at 45 MHz results in a spectrally inverted OFDM signal centred at approximately 8.9 MHz . The first step of the demodulation process is to convert this signal to a complex (in-phase and quadrature) signal in baseband. A correction for spectral inversion is implemented during this conversion process. Note also that the ZL10354 has control mechanisms to search automatically for an unknown spectral inversion status.

### 2.4 Adjacent Channel Filtering

Adjacent channels, in particular the Nicam digital sound signal associated with analog channels, are filtered prior to the FFT.

### 2.5 Interpolation and Clock Synchronization

ZL10354 uses digital timing recovery and this eliminates the need for an external VCXO. The ADC samples the signal at a fixed rate, for example, 45.056 MHz . Conversion of the 45.056 MHz signal to the OFDM sample rate is achieved using the time-varying interpolator. The OFDM sample rate is $64 / 7 \mathrm{MHz}$ for 8 MHz and this is scaled by factors $6 / 8$ and $7 / 8$ for 6 and 7 MHz channel bandwidths. The nominal ratio of the ADC to OFDM sample rate is programmed in a ZL10354 register (defaults are for 45 MHz sampling and 8 MHz OFDM). The clock recovery phase locked loop in the ZL10354 compensates for inaccuracies in this ratio due to uncertainties of the frequency of the sampling clock.

### 2.6 Carrier Frequency Synchronization

There can be frequency offsets in the signal at the input to OFDM, partly due to tuner step size and partly due to broadcast frequency shifts, typically $1 / 6 \mathrm{MHz}$. These are tracked out digitally, up to 1 MHz in 2 K and 8 K modes, without the need for an analog frequency control (AFC) loop.

The default frequency capture range has been set to $\pm 286 \mathrm{kHz}$ in the 2 K and 8 K mode. However, these values can be increased, if necessary, by programming an on-chip register (see 7.4.1). It is recommended that a larger capture range be used for channel scan in order to find channels with broadcast frequency shifts, without having to adjust the tuner. After the OFDM module has locked (the AFC will have been previously disabled), the frequency offset can be read from an on-chip register.

### 2.7 Symbol Timing Synchronization

This module computes the optimum sample position to trigger the FFT in order to eliminate or minimize inter-symbol interference in the presence of multi-path distortion. Furthermore, this trigger point is continuously updated to dynamically adapt to time-variations in the transmission channel.

### 2.8 Fast Fourier Transform

The FFT module uses the trigger information from the timing synchronization module to set the start point for an FFT. It then uses either a 2 K or 8 K FFT to transform the data from the time domain to the frequency domain. An extremely hardware-efficient and highly accurate algorithm has been used for this purpose.

### 2.9 Common Phase Error Correction

This module subtracts the common phase offset from all the carriers of the OFDM signal to minimize the effect of the tuner phase noise on system performance.

### 2.10 Channel Equalization

This consists of two parts. The first part involves estimating the channel frequency response from pilot information. Efficient algorithms have been used to track time-varying channels with a minimum of hardware.

The second part involves applying a correction to the data carriers based on the estimated frequency response of the channel. This module also generates dynamic channel state information (CSI) for every carrier in every symbol.

### 2.11 Impulse Filtering

ZL10354 contains several mechanisms to reduce the impact of impulse noise on system performance.

### 2.12 Transmission Parameter Signalling (TPS)

An OFDM frame consists of 68 symbols and a superframe is made up of four such frames. There is a set of TPS carriers in every symbol and all these carry one bit of TPS. These bits, when combined, include information about the transmission mode, guard ratio, constellation, hierarchy and code rate, as defined in ETS 300744 . In addition, the first eight bits of the cell identifier are contained in even frames and the second eight bits of the cell identifier are in odd frames. The TPS module extracts all the TPS data, and presents these to the host processor in a structured manner.

### 2.13 Diversity Optimizer

When two or more ZL10354s are combined in a chain using their diversity buses, the first stage chip operates in the normal way on a single tuner source, however the channel-corrected OFDM data are output to the next device in the chain. This ZL10354 combines the received diversity data with the channel-corrected data from its own OFDM demodulation process, selecting the optimum data from each source for any given carrier. The resulting data are either passed to another ZL10354 for further combining, or the FEC logic to generate an MPEG transport stream.

### 2.14 De-Mapper

This module generates soft decisions for demodulated bits using the channel-equalized in-phase and quadrature components of the data carriers as well as per-carrier channel state information (CSI). The de-mapping algorithm depends on the constellation (QPSK, 16QAM or 64QAM) and the hierarchy ( $\alpha=0,1,2$ or 4 ). Soft decisions for both low- and high-priority data streams are generated.

### 2.15 Symbol and Bit De-Interleaving

The OFDM transmitter interleaves the bits within each carrier and also the carriers within each symbol. The de-interleaver modules consist largely of memory to invert these interleaving functions and present the soft decisions to the FEC in the original order.

### 2.16 Viterbi Decoder

The Viterbi decoder accepts the soft decision data from the OFDM demodulator and outputs a decoded bit-stream. The decoder does the de-puncturing of the input data for all code rates other than $1 / 2$. It then evaluates the branch metrics and passes these to a 64-state path-metric updating unit, which in turn outputs a 64 -bit word to the survivor memory. The Viterbi decoded bits are obtained by tracing back the survivor paths in this memory. A trace-back depth of 128 is used to minimize any loss in performance, especially at high code rates.

The decoder re-encodes the decoded bits and compares these with received data (delayed) to compute bit errors at its input, on the assumption that the Viterbi output BER is significantly lower than its input BER.

### 2.17 MPEG Frame Aligner

The Viterbi decoded bit stream is aligned into 204-byte frames. A robust synchronization algorithm is used to ensure correct lock and to prevent loss of lock due to noise impulses.

### 2.18 De-interleaver

Errors at the Viterbi output occur in bursts and the function of the de-interleaver is to spread these errors over a number of 204-byte frames to give the Reed-Solomon decoder a better chance of correcting these. The de-interleaver is a memory unit which implements the inverse of the convolutional interleaving function introduced by the transmitter.

### 2.19 Reed-Solomon Decoder

Every 188 -byte transport packet is encoded by the transmitter into a 204-byte frame, using a truncated version of a systematic $(255,239)$ Reed-Solomon code. The corresponding $(204,188)$ Reed-Solomon decoder is capable of correcting up to eight byte errors in a 204-byte frame. It may also detect frames with more than eight byte errors.

In addition to efficiently performing this decoding function, the Reed-Solomon decoder in ZL10354 keeps a count of the number of bit errors corrected over a programmable period and the number of uncorrectable blocks. This information can be used to compute the post-Viterbi BER.

### 2.20 De-scrambler

The de-scrambler de-randomizes the Reed-Solomon decoded data by generating the exclusive-OR of this with a pseudo-random bit sequence (PRBS). This outputs 188-byte MPEG transport packets. The TEI bit of the packet header may be set if required to indicate uncorrectable packets.

### 2.21 MPEG Transport Interface

MPEG data can be output in parallel or serial mode. The output clock frequency is automatically chosen to present the MPEG data as uniformly spaced as possible to the transport processor. This frequency depends on the guard ratio, constellation, hierarchy and code rate. There is also an option for the data to be extracted from the ZL10354 with a clock provided by the user.

### 3.0 Diversity Operation of ZL10354

The ZL10354 demodulator can be used as a stand-alone system, but is designed primarily for use as part of a multi-receiver system in which two or more tuners, each with their own aerial, are connected to the same number of ZL10354s. This is shown in general form in Figure 5.


Figure 5-Outline Diversity System
The ZL10354s are connected together in a chain using the diversity data bus, a high-speed, 5 -bit bus which feeds channel-corrected, ODFM data to the next demodulator in the chain. Each subsequent ZL10354 combines the incoming OFDM data with its own received data to get the optimum reception for each carrier.

The SADD1 and SADD0 pins allow up to four ZL10354s to each be defined with a different serial bus address, but the system is not limited to four devices. However, each group of (up to) four ZL10354s must be controlled via a separate serial bus to avoid address clashes. The other main requirement is that all the demodulators are driven from the same clock source.

The diversity data are transferred from one device to the next through either the diversity pins, or parts of the MPEG bus, which isn't (usually) required on any device other than the last. The diversity bus pins are very flexible, being definable as either inputs or outputs, and when defined as inputs, the data pin order can be swapped. This flexibility eases the PCB layout issues considerably. In effect, six different pinouts can be defined for the ZL10354, in addition to the default non-diversity pinout. These pinout possibilities are shown in detail in Table 6, the non-diversity pin list is in Table 5, and the two main diversity pin list options are in Table 3 and Table 4. In these latter two tables the bus pin swap options are not shown.

The versatility of this approach can be demonstrated with a dual receiver system (see Figure 6) in which the two ZL10354 based receivers can function either as a single diversity receiver, giving improved reception in mobile environments, or as a dual non-diversity receiver where two MPEG streams from different channels are required for picture-in-picture or play-and-record applications.


Figure 6-Outline of Dual Diversity/Play-and-Record System
Although the two functions are very different, this one hardware design can easily be used in either mode just by setting the appropriate diversity register bits, and of course using appropriate software for tuning the same channel on both receivers, or two different channels.

### 3.1 Pin Allocation

| Pin | Function | Pin | Function | Pin | Function | Pin | Function |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Vss | 17 | SADD1 | 33 | Vdd | 49 | MDOO |
| 2 | Vdd | 18 | SADD0 | 34 | RFLEV | 50 | MDO1 |
| 3 | Vss | 19 | CVdd | 35 | CLK2/GPP0 | 51 | MDO2 |
| 4 | CLK1 | 20 | Vss | 36 | DATA2/GPP1 | 52 | MDO3 |
| 5 | DATA1 | 21 | PLLVdd | 37 | CVdd | 53 | MDO4 |
| 6 | Dv4 ${ }^{1}$ | 22 | PLLGND | 38 | Vss | 54 | Vdd |
| 7 | CVdd | 23 | $\overline{\mathrm{XTI}}$ | 39 | CVdd | 55 | Vss |
| 8 | Vss | 24 | XTO | 40 | Vss | 56 | MDO5 |
| 9 | RESET | 25 | Vss | 41 | DvVal ${ }^{3}$ | 57 | MDO6 |
| 10 | SLEEP | 26 | PLLTEST | 42 | AGC1 | 58 | MDO7 |
| 11 | Dv3 ${ }^{2}$ | 27 | OSCMODE | 43 | DvClk ${ }^{3}$ | 59 | CVdd |
| 12 | Dv2 ${ }^{3}$ | 28 | AVdd | 44 | SMTEST | 60 | Vss |
| 13 | Vdd | 29 | AGnd | 45 | Vdd | 61 | MOCLK |
| 14 | Vss | 30 | VIN | 46 | Vss | 62 | $\overline{\text { BKERR }}$ |

Table 3 - Pin Names Mode A-diversity first or last device in chain

| Pin | Function | Pin | Function | Pin | Function | Pin | Function |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 15 | Dv1 $^{4}$ | 31 | $\overline{\text { VIN }}$ | 47 | MOSTRT | 63 | MICLK |
| 16 | Dv0 $^{5}$ | 32 | AGnd | 48 | MOVAL | 64 | CVdd |

Table 3 - Pin Names Mode A - diversity first or last device in chain (continued)

1. Can be defined as either an input or output and can be swapped with Dv0 when used as an input.
2. Can be defined as either an input or output and can be swapped with Dv1 when used as an input.
3. Can be defined as either an input or output.
4. Can be defined as either an input or output and can be swapped with Dv3 when used as an input.
5. Can be defined as either an input or output and can be swapped with Dv4 when used as an input.

| Pin | Function | Pin | Function | Pin | Function | Pin | Function |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Vss | 17 | SADD1 | 33 | Vdd | 49 | Dv0-O |
| 2 | Vdd | 18 | SADD0 | 34 | RFLEV | 50 | Dv1-O |
| 3 | Vss | 19 | CVdd | 35 | CLK2/GPP0 | 51 | Dv2-O |
| 4 | CLK1 | 20 | Vss | 36 | DATA2/GPP1 | 52 | Dv3-O |
| 5 | DATA1 | 21 | PLLVdd | 37 | CVdd | 53 | Dv4-O |
| 6 | Dv4-I ${ }^{1}$ | 22 | PLLGND | 38 | Vss | 54 | Vdd |
| 7 | CVdd | 23 | $\overline{\mathrm{XTI}}$ | 39 | CVdd | 55 | Vss |
| 8 | Vss | 24 | XTO | 40 | Vss | 56 | MDO5 ${ }^{4}$ |
| 9 | $\overline{\text { RESET }}$ | 25 | Vss | 41 | DvVal-I | 57 | MDO6 ${ }^{4}$ |
| 10 | SLEEP | 26 | PLLTEST | 42 | AGC1 | 58 | MDO7 ${ }^{4}$ |
| 11 | Dv3-I ${ }^{2}$ | 27 | OSCMODE | 43 | DvClk-I | 59 | CVdd |
| 12 | Dv2-I | 28 | AVdd | 44 | SMTEST | 60 | Vss |
| 13 | Vdd | 29 | AGnd | 45 | Vdd | 61 | DvCIk-O |
| 14 | Vss | 30 | VIN | 46 | Vss | 62 | $\overline{\text { BKERR }}$ |
| 15 | Dv1-1 ${ }^{3}$ | 31 | $\overline{\mathrm{VIN}}$ | 47 | MOSTRT ${ }^{4}$ | 63 | MICLK |
| 16 | Dv0-1 ${ }^{5}$ | 32 | AGnd | 48 | DvVal-O | 64 | CVdd |

Table 4 - Pin Names Mode B-diversity mid-chain device

1. Can be swapped with Dv0-I
2. Can be swapped with Dv1-I
3. Can be swapped with Dv3-I
4. Held low in this mode
5. Can be swapped with Dv4-I

| Pin | Function | Pin | Function | Pin | Function | Pin | Function |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 1 | Vss | 17 | SADD1 | 33 | Vdd | 49 | MDO0 |
| 2 | Vdd | 18 | SADD0 | 34 | RFLEV | 50 | MDO1 |
| 3 | Vss | 19 | CVdd | 35 | CLK2/GPP0 | 51 | MDO2 |
| 4 | CLK1 | 20 | Vss | 36 | DATA2/GPP1 | 52 | MDO3 |
| 5 | DATA1 | 21 | PLLVdd | 37 | CVdd | 53 | MDO4 |

Table 5 - Pin Names Mode C-non-diversity use

| Pin | Function | Pin | Function | Pin | Function | Pin | Function |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 6 | $\overline{\text { IRQ }}$ | 22 | PLLGND | 38 | Vss | 54 | Vdd |
| 7 | CVdd | 23 | $\overline{\text { XTI }}$ | 39 | CVdd | 55 | Vss |
| 8 | Vss | 24 | XTO | 40 | Vss | 56 | MDO5 |
| 9 | $\overline{\text { RESET }}$ | 25 | Vss | 41 | AGC2/GPP2 | 57 | MDO6 |
| 10 | SLEEP | 26 | PLLTEST | 42 | AGC1 | 58 | MDO7 |
| 11 | STATUS | 27 | OSCMODE | 43 | GPP3 | 59 | CVdd |
| 12 | N/C | 28 | AVdd | 44 | SMTEST | 60 | Vss |
| 13 | Vdd | 29 | AGnd | 45 | Vdd | 61 | MOCLK |
| 14 | Vss | 30 | VIN | 46 | Vss | 62 | $\overline{\text { BKERR }}$ |
| 15 | N/C | 31 | $\overline{\text { VIN }}$ | 47 | MOSTRT | 63 | MICLK |
| 16 | N/C | 32 | AGnd | 48 | MOVAL | 64 | CVdd |

Table 5 - Pin Names Mode C - non-diversity use (continued)
In Table 6 all the possible variations are shown, of which pin numbers on the ZL10354 can be used for each of the diversity bus functions. This versatility - six different diversity pinout options - eases board layout constraints and allows the high speed diversity data buses between devices to be kept as short as possible.

Control of the diversity hardware functions is through six bits, three in the CONFIG register (address 0x50, see page 56) and three in the DVR_CTL register (address 0x59, see page 56). The function of these bits is described in detail in the relevant register descriptions, which should be read in conjunction with reference to Table 6.

| 들을0 | $\begin{aligned} & \text { 능 } \\ & \text { Q } \\ & \text { B } \end{aligned}$ |  |  | 0$\substack{0 \\ 0 \\ 3 \\ 0}$ | Dvo |  | Dv1 |  | Dv2 |  | Dv3 |  | Dv4 |  | DvClk |  | DvVal |  | $\begin{aligned} & 0 \\ & \text { O } \\ & \text { ㅇ } \end{aligned}$ | $\begin{aligned} & \text { 끌 } \\ & 0 \\ & \text { 듬 } \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | $\underset{0}{\overrightarrow{7}}$ | 드 | $\underset{0}{7}$ | $\underline{\underline{C}}$ | $\underset{0}{7}$ | $\underline{\text { ㄷ }}$ | $\underset{0}{\overrightarrow{3}}$ | 드 | $\stackrel{\text { r }}{3}$ | 듣 | $\underset{0}{7}$ | $\underline{\text { 듣 }}$ | $\stackrel{T}{J}$ | 드 |  |  |
| 1 | 0 | 1 | 0 | X | 16 | - | 15 | - | 12 | - | 11 | - | 6 | - | 43 | - | 41 | - | A | Table $3^{1}$ |
| 0 | X | 1 | 1 | 0 | - | 16 | - | 15 | - | 12 | - | 11 | - | 6 | - | 43 | - | 41 |  | Table $3^{2}$ |
| 0 | X | 1 | 1 | 1 | - | 6 | - | 11 | - | 12 | - | 15 | - | 16 | - | 43 | - | 41 |  | Table $3^{2,4}$ |
| 1 | 1 | 0 | 0 | X | 49 | - | 50 | - | 51 | - | 52 | - | 53 | - | 61 | - | 48 | - | B | Table $4^{1,3}$ |
| 1 | 1 | 1 | 1 | 0 | 49 | 16 | 50 | 15 | 51 | 12 | 52 | 11 | 53 | 6 | 61 | 43 | 48 | 41 |  | Table 4 |
| 1 | 1 | 1 | 1 | 1 | 49 | 6 | 50 | 11 | 51 | 12 | 52 | 15 | 53 | 16 | 61 | 43 | 48 | 41 |  | Table $4{ }^{4}$ |
| 0 | X | 0 | 0 | X | - | - | - | - | - | - | - | - | - | - | - | - | - | - | C | Table 5 |

Table 6 - Diversity Pin Configurations

1. Option for the first device in a diversity chain.
2. Option for the last device in a diversity chain.
3. Diversity input pins can be used for their non-diversity functions as in Table 5.
4. Dv0 to Dv4 inputs are reversed relative to the names given in Table 3/Table 4.


Figure 7 - Basic Interconnections and Serial Address Options for Four ZL10354s on the Same Bus

### 4.0 Interfaces

### 4.1 2-Wire Bus

### 4.1.1 Host

The primary 2-wire bus serial interface uses pins:

- DATA1 (pin 5) serial data, the most significant bit is sent first.
- CLK1 (pin 4) serial clock.

The 2-wire bus address is determined by applying VDD or VSS to the SADD[4:0] pins.
In TNIM evaluation applications, the 2-wire bus address is $0001111 \mathrm{R} / \overline{\mathrm{W}}$ with the pins connected as follows:

| ADDR[7] | ADDR[6] | ADDR[5] | ADDR[4] | ADDR[3] | ADDR[2] | ADDR[1] |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Not programmable |  |  |  |  |  | SADD[1] |
| SADD[0] |  |  |  |  |  |  |
| VSS | VSS | VSS | VDD | VDD | VDD | VDD |

When the ZL10354 is powered up, the RESET pin 9 should be held low for at least 50 ms after VDD has reached normal operation levels. As the RESET pin goes high, the logic levels on SADD[4:0] are latched as the 2 -wire bus address. ADDR[0] is the $\mathrm{R} / \overline{\mathrm{W}}$ bit.

The circuit works as a slave transmitter with the Isb set high or as a slave receiver with the Isb set low. In receive mode, the first data byte is written to the RADD virtual register, which forms the register sub-address. The RADD register takes an 8-bit value that determines which of 256 possible register addresses is written to by the following byte. Not all addresses are valid and many are reserved registers that must not be changed from their default values. Multiple byte reads or writes will auto-increment the value in RADD, but care should be taken not to access the reserved registers accidentally.

Following a valid chip address, the 2-wire bus STOP command resets the RADD register to 00 . If the chip address is not recognized, the ZL10354 will ignore all activity until a valid chip address is received. The 2 -wire bus START command does NOT reset the RADD register to 00 . This allows a combined 2 -wire bus message, to point to a particular read register with a write command, followed immediately with a read data command. If required, this could next be followed with a write command to continue from the latest address. RADD would not be sent in this case. Finally, a STOP command should be sent to free the bus.

When the 2-wire bus is addressed (after a recognized STOP command) with the read bit set, the first byte read out is the contents of register 00.

### 4.1.2 Tuner

The ZL10354 has a General Purpose Port that can be configured to provide a secondary 2 -wire bus. See register GPP_CTL address 0x8C.

Master control mode is selected by setting register SCAN_CTL (0x62) [b3] $=1$.
The allocation of the pins is: GPP0 pin $35=$ CLK2, GPP1 pin $36=$ DATA2.

### 4.1.3 Examples of 2-Wire Bus Messages

KEY:

| S | Start condition |
| :--- | :--- |
| P | Stop condition |
| A | Acknowledge |
| Italics | ZL10354 output |


| W | Write $(=0)$ |
| :--- | :--- |
| R | Read (=1) |
| NA | NOT Acknowledge |
| RADD | Register Address |

Write operation - as a slave receiver:

| S | DEVICE <br> ADDRESS | W | $\boldsymbol{A}$ | RADD <br> $(\mathrm{n})$ | $\boldsymbol{A}$ | DATA <br> $($ reg n$)$ | $\boldsymbol{A}$ | DATA <br> $($ reg $\mathrm{n}+1)$ | $\boldsymbol{A}$ | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |

Read operation - ZL10354 as a slave transmitter:

| S | DEVICE <br> ADDRESS | R | A | DATA <br> (reg $\mathbf{0})$ | A | DATA <br> (reg 1) | A | DATA <br> (reg 2) | NA | P |
| :--- | :---: | :--- | :--- | :---: | :--- | :---: | :---: | :---: | :---: | :---: |

Write/read operation with repeated start - ZL10354 as a slave transmitter:

| S | DEVICE <br> ADDRESS | W | A | RADD <br> $(\mathrm{n})$ | $\boldsymbol{A}$ | S | DEVICE <br> ADDRESS | R | A | DATA <br> $($ reg $\boldsymbol{n})$ | A | DATA <br> $($ reg $n+1)$ | NA | P |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

### 4.1.4 Primary 2-Wire Bus Timing



Figure 8 - Primary 2-Wire Bus Timing
Where:

$$
\begin{aligned}
& \text { S = Start } \\
& \text { Sr = Restart, i.e., start without stopping first. } \\
& P=\text { Stop. }
\end{aligned}
$$

| Parameter | Symbol | Value |  | Unit |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. |  |
| CLK clock frequency (Primary) | ${ }^{\text {f CLK }}$ | 0 | $400{ }^{1}$ | kHz |
| Bus free time between a STOP and START condition. | $\mathrm{t}_{\text {BUFF }}$ | 200 |  | ns |
| Hold time (repeated) START condition. | $\mathrm{t}_{\mathrm{HD} ; \mathrm{STA}}$ | 200 |  | ns |
| LOW period of CLK clock. | tow | 1300 |  | ns |
| HIGH period of CLK clock. | $\mathrm{t}_{\text {HIGH }}$ | 600 |  | ns |
| Set-up time for a repeated START condition. | ${ }^{\text {tsu; }}$ STA | 200 |  | ns |
| Data hold time (when input). | $\mathrm{t}_{\mathrm{HD} ; \text { DAT }}$ | 100 |  | ns |
| Data set-up time | $\mathrm{t}_{\text {SU; }{ }^{\text {dat }} \text { }}$ | 100 |  | ns |
| Rise time of both CLK and DATA signals. | $t_{R}$ |  | note ${ }^{2}$ | ns |
| Fall time of both CLK and DATA signals, ( 100 pF to ground). | $\mathrm{t}_{\mathrm{F}}$ | 20 |  | ns |
| Set-up time for a STOP condition. | $\mathrm{t}_{\text {Su; }}$ STO | 200 |  | ns |

Table 7 - Timing of 2-Wire Bus

1. If operating with an external 4 MHz clock, the serial clock frequency is reduced to 100 kHz maximum.
2. The rise time depends on the external bus pull up resistor. Loading prevents full speed operation.

### 4.2 Diversity Bus

The diversity bus is a high speed 5-bit data bus that allows OFDM data from multiple ZL10354s to be optimized on a carrier by carrier basis. The diversity clock is output at the ADC clock rate and in the receiving device latches the data and validation bit on the rising edge. To achieve this with the optimum timing parameters, the clock should be inverted by setting the DvrClkInv bit in the DVR_CTL register (address 0x59) as part of the setup routine when using a diversity system.


Figure 9 - Timing Diagram for the Diversity Bus with DvrClkInv = 1

| Parameter | Timing conditions |  | Units |
| :--- | :--- | :--- | :--- |
|  | Minimum | Maximum |  |
| Diversity clock period $\mathrm{t}_{\text {DvrP }}$ | 22.06 | 28.48 | n |
| Diversity setup time $\mathrm{t}_{\text {DvrSU }}$ | tba |  |  |
| Diversity hold time $\mathrm{t}_{\text {DvrH }}$ | tba |  |  |

Table 8 - Diversity Bus Timing

### 4.3 MPEG

### 4.3.1 Data Output Header Format



Figure 10 - DVB Transport Packet Header Byte
After decoding the 188 -byte MPEG packet, it is output on the MDO pins in 188 consecutive clock cycles.
Additionally when the TEI_En bit in the OP_CTRL_0 register ( $0 \times 5 \mathrm{~A}$ ) is set high (default), the TEI bit of any uncorrectable packet will automatically be set to ' 1 '. If TEI_En bit is low then TEI bit will not be changed (but note that if this bit is already 1 , for example, due to a channel error which has not been corrected, it will remain high at output).

### 4.3.2 MPEG Data Output Signals

The MPEGEN bit in the CONFIG register must be set low to enable the MPEG data. The maximum movement in the packet synchronization byte position is limited to $\pm 1$ output clock period. MOCLK will be a continuously running clock once symbol lock has been achieved, and is derived from the symbol clock. MOCLK is shown in Figure 11 with MOCLKINV = ' 1 ', the default state, see register $0 \times 50$.

All output data and signals (MDO[7:0], MOSTRT, MOVAL \& BKERR) change on the negative edge of MOCLK (MOCLKINV $=1$ ) to present stable data and signals on the positive edge of the clock.

A complete packet is output on MDO[7:0] on 188 consecutive clocks and the MDO[7:0] pins will remain low during the inter-packet gaps. MOSTRT goes high for the first byte clock of a packet. MOVAL goes high on the first byte of a packet and remains high until the last byte has been clocked out. BKERR goes low on the first byte of a packet where uncorrectable bytes are detected and will remain low until the last byte has been clocked out.


Figure 11 - MPEG Output Data Waveforms

### 4.3.3 MPEG Output Timing

Maximum delay conditions: VDD $=3.0 \mathrm{~V}, \mathrm{CVDD}=1.62 \mathrm{~V}$, $\mathrm{Tamb}=85^{\circ} \mathrm{C}$, Output load $=10 \mathrm{pF}$.
Minimum delay conditions: VDD $=3.6 \mathrm{~V}, \mathrm{CVDD}=1.98 \mathrm{~V}$, $\operatorname{Tamb}=-40^{\circ} \mathrm{C}$, Output load $=10 \mathrm{pF}$.
MOCLK frequency $=45.06 \mathrm{MHz}$.

### 4.3.4 $\operatorname{MOCLKINV}=1$

| Parameter | Delay conditions |  | Units |
| :--- | :---: | :---: | :---: |
|  | Maximum | Minimum |  |
| Data output delay $\mathrm{t}_{\mathrm{D}}$ | 3.0 | 1.0 | ns |
| Setup Time $\mathrm{t}_{\mathrm{S}} \mathrm{E}$ | 7.0 | 10.0 |  |
| Hold Time $\mathrm{t}_{\mathrm{H}}$ | 7.0 | 10.0 |  |



Figure 12 - MPEG Timing - MOCLKINV = 1

### 4.3.5 $\operatorname{MOCLKINV}=0$

MDOSWAP $=0$

| Parameter | Delay conditions |  | Units |
| :--- | :---: | :---: | :---: |
|  | Maximum | Minimum |  |
| Data output delay $\mathrm{t}_{\mathrm{D}}$ | 3.0 | 1.0 |  |
| Setup Time $\mathrm{t}_{\mathrm{S}}$ | 18.0 | 20.0 | ns |
| Hold Time $\mathrm{t}_{\mathrm{H}}$ | 1.0 | 0.2 |  |

The hold time is better when MOCLKINV $=1$, therefore this should be used if possible.


Figure 13 - MPEG Timing - MOCLKINV $=0$

### 5.0 Electrical Characteristics

### 5.1 Recommended Operating Conditions

| Parameter | Symbol | Min. | Typ. | Max. | Units |  |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: |
| Power supply voltage: | periphery | VDD | 3.0 | 3.3 | 3.6 | V |
|  | core | CVDD | 1.62 | 1.8 | 1.98 | V |
| Power supply current: | periphery ${ }^{1}$ | IDD $_{\text {P }}$ |  | 1 |  | mA |
|  | core | IDD $_{\text {C }}$ |  | 170 |  | $\mathrm{~mA}^{2}$ |
| Input clock frequency ${ }^{3}$ |  | XTI | 16.00 | 20.48 | 25.00 | MHz |
| CLK1 primary serial clock frequency ${ }^{4}$ |  | fCLK |  |  | 400 | kHz |
| Ambient operating temperature |  | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |  |

1. Current from the 3.3 V supply will be mainly dependent on the external loads.
2. Current given is for optimum performance, lower current is possible with reduced performance.
3. The $\mathrm{min} / \mathrm{max}$ frequencies given are those supported by the oscillator cell. Required system frequencies are as defined in the design manual. Frequencies outside these limits are acceptable with an external clock signal.
4. If operating with an external 4 MHz clock, the serial clock frequency is reduced to 100 kHz maximum.

### 5.2 Absolute Maximum Ratings

## Maximum Operating Conditions

| Parameter | Symbol | Min. | Max. | Unit |
| :--- | :--- | :---: | :---: | :---: |
| Power supply | VDD | -0.3 | +3.6 | V |
|  | CVDD | -0.3 | +2.0 | V |
| Voltage on input pins (5 V rated) | VI | -0.3 | 5.5 | V |
| Voltage on input pins (3.3 V rated) | VI | -0.3 | $\mathrm{VDD}+0.3$ | V |
| Voltage on output pins (5 V rated) | VO | -0.3 | 5.5 | V |
| Voltage on output pins (3.3 V rated) | VO | -0.3 | $\mathrm{VDD}+0.3$ | V |
| Storage temperature | TSTG | -55 | 150 | ${ }^{\circ} \mathrm{C}$ |
| Operating ambient temperature | TOP | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |
| Junction temperature | TJ |  | 125 | ${ }^{\circ} \mathrm{C}$ |

Note: Stresses exceeding these listed under absolute maximum ratings may induce failure. Exposure to absolute maximum ratings for extended periods may reduce reliability. Functionality at or above these conditions is not implied.

### 5.3 DC Electrical Characteristics

## DC Electrical Characteristics

| Parameter | Conditions | Pins | Symbol | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating <br> voltage periphery |  |  | VDD | 3.0 | 3.3 | 3.6 | V |
| core |  |  | CVDD | 1.62 | 1.8 | 1.98 | V |
| Supply current ${ }^{1}$ | $1.62 \geq$ CVDD $\geq 1.98$ |  | IDDCORE |  | 170 |  | mA |
| Supply current sleep mode |  |  |  |  | 300 |  | $\mu \mathrm{A}$ |
| Outputs |  |  |  |  |  |  |  |
| Output levels | $\begin{aligned} & \mathrm{OH} 2 \mathrm{~mA} \\ & 3.0 \geq \mathrm{VDD} \geq 3.6 \end{aligned}$ | MDO(7:0), MOVAL, MOSTRT, MOCLK, STATUS, BKERR | VOH | 2.4 |  |  | V |
|  | $\begin{aligned} & \mathrm{IOL} 2 \mathrm{~mA} \\ & 3.0 \geq \mathrm{VDD} \geq 3.6 \end{aligned}$ |  | VOL |  |  | 0.4 | V |
|  | $\begin{aligned} & \mathrm{IOL} 6 \mathrm{~mA} \\ & 3.0 \geq \mathrm{VDD} \geq 3.6 \end{aligned}$ | $\begin{aligned} & \text { GPP(3:0), DATA1, } \\ & \text { AGC1, AGC2, } 1 \text { RQ } \end{aligned}$ | VOL |  |  | 0.4 | V |
| Output capacitance | Not including track | MDO(7:0), MOVAL, MOSTRT, MOCLK, STATUS, BKERR |  |  | 3.0 |  | pF |
|  |  | $\begin{aligned} & \text { GPP(3:0), DATA1, } \\ & \text { AGC1, AGC2,IRQ } \end{aligned}$ |  |  | 3.6 |  | pF |
| Output leakage (tri-state) |  |  |  |  |  | 1 | $\mu \mathrm{A}$ |
| Inputs |  |  |  |  |  |  |  |
| Input levels | $\begin{aligned} & 3.0 \geq \mathrm{VDD} \geq 3.6 \\ & -0.5 \geq \operatorname{Vin} \geq \\ & \mathrm{VDD}+0.5 \mathrm{~V} \end{aligned}$ | MICLK, SADD(4:0) SLEEP, OSCMODE | VIH | 2.0 |  |  | V |
| Input levels | $\begin{aligned} & 3.0 \geq \mathrm{VDD} \geq 3.6 \\ & -0.5 \geq \operatorname{Vin} \geq+5.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \text { GPP(3:0), CLK1, } \\ & \text { DATA1, }, \text { RESET } \end{aligned}$ | VIH | 2.0 |  |  | V |
| Input levels | $3.0 \geq \mathrm{VDD} \geq 3.6$ <br> Capacitances do not include track | All inputs | VIL |  |  | 0.8 | V |
| Input leakage Current |  | SLEEP, SMTEST, MICLK, CLK1, OSCMODE |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| Input capacitance |  |  |  |  | 1.8 |  | pF |
| Input capacitance |  | $\begin{aligned} & \operatorname{SADD}(4: 0), \text { DATA1, } \\ & \operatorname{GPP}(3: 0) \end{aligned}$ |  |  | 3.6 |  | pF |

1. Current given is for optimum performance, lower current is possible with reduced performance.

### 5.4 Crystal Specification and External Clocking

Parallel resonant fundamental frequency (preferred)
Tolerance over operating temperature range
Tolerance overall
Typical load capacitance
Drive level
Equivalent series resistance
20.4800 MHz
$\pm 150 \mathrm{ppm}$
$\pm 200 \mathrm{ppm}$
27 pF
0.4 mW max
$<25 \Omega$


Figure 14-Crystal Oscillator Circuit

### 5.4.1 Selection of External Components

The capacitor values used must ensure correct operation of the Pierce oscillator such that the total loop gain is greater than unity. Correct selection of the two capacitors is very important and the following method is recommended to obtain values for C 1 and C 2 .

### 5.4.1.1 Loop Gain Equation

Although oscillation may still occur if the loop gain is just above 1 , a loop gain of between 5 and 25 is optimum to ensure that oscillations will occur across all variations in temperature, process and supply voltage, and that the circuit will exhibit good start-up characteristics.

Equation 1- $\quad A=\frac{C_{\text {out }} \cdot g_{m}}{C_{\text {in }}}\left[\frac{C_{\text {out }}+C_{\text {in }}}{R_{f} \cdot C_{\text {in }}}+\frac{1}{Z_{\text {in }}}+\frac{1}{Z_{o}}\right]^{-1}$
Equation 2- $\cdot \mathrm{Z}_{\text {in }}=\frac{1}{\left(2 . \pi . f . \mathrm{C}_{\text {out }}\right)^{2} \text {.ESR }}$

### 5.4.1.2 List of Equation Parameters

A total loop gain (between 5 and 25)
Cin C1 + Cpar
Cout C2 + Cpar
Cpar parasitic capacitance associated with each oscillator pin ( $\overline{\mathrm{XTI}}$ and XTO). It consists of track capacitances, package capacitance and cell input capacitance. Normally Cpar $\approx 4 \mathrm{pF}$.
Zo $\quad 9.143 \mathrm{k} \Omega$ - output impedance of amplifier at 1.8 V operation - typical
gm $\quad 8.736 \mathrm{~mA} / \mathrm{V}$ - transconductance of amplifier at 1.8 V operation -typical
Rf $\quad 2.3 \mathrm{M} \Omega$ - internal feedback resistor
ESR maximum equivalent series resistance of crystal - given by crystal manufacturer ( $\Omega$ )
f fundamental frequency of crystal ( Hz )

### 5.4.1.3 Calculating Crystal Power Dissipation

To calculate the power dissipated in a crystal the following equation can be used.
Equation 3- $\quad P_{c}=\frac{V_{p p}{ }^{2}}{8 . Z_{i n}}$
Pc = power dissipated in crystal at resonant frequency (W)
Vpp = maximum peak to peak output swing of amplifier is 1.8 V for all CVDD
Zin = crystal network impedance (see Equation 2)

### 5.4.1.4 Capacitor Values

Using the loop gain limits ( $5 \leq \mathrm{A} \leq 25$ ), the maximum and minimum values for C 1 and C 2 can be calculated with Equation 4 below.
Equation 4- $\quad C_{i n}=C_{o u t}=\sqrt{\left[\frac{g_{m}}{A}-\frac{2}{R_{f}}-\frac{1}{Z_{o}}\right] \cdot \frac{1}{(2 \cdot \pi \cdot f)^{2} \cdot E S R}}$ when: $C_{1}=C_{2}=C_{o u t}-C_{p a r}$

Note: Equation 4 was derived from Equation 1 and Equation 2 using the premise that $\mathrm{C} 1=\mathrm{C} 2$.
Within these limits, any value for C1 and C2 can now be selected. Normally C1 and C2 are chosen such that the resulting crystal load capacitance $C_{L}$ (see Equation 5) is close to the crystal manufacturers recommended $C_{L}$ (standard values for $\mathrm{C}_{\mathrm{L}}$ are $15 \mathrm{pF}, 20 \mathrm{pF}$ and 30 pF ). The crystal will then operate very near its specified frequency.

Equation 5- $\quad C_{L}=\frac{C_{\text {out }} \cdot C_{\text {in }}}{C_{\text {out }}+C_{\text {in }}}+C_{\text {par12 }}$
$\mathrm{C}_{\text {par12 }}=$ parasitic capacitance between the $\overline{\mathrm{XTI}}$ and XTO pins. It consists of the IC package's pin-to-pin capacitance (including any socket used) and the printed circuit board's track-to-track capacitance.
$\mathrm{C}_{\text {par12 }} \approx 2 \mathrm{pF}$.
If some frequency pulling can be tolerated, a crystal load capacitance different from the crystal manufacturer's recommended $C_{L}$ may be acceptable. Larger values of $C_{L}$ tend to reduce the influence of circuit variations and tolerances on frequency stability. Smaller values of $C_{L}$ tend to reduce startup time and crystal power dissipation. Care must however be taken that $C_{L}$ does not fall outside the crystal pulling range or the circuit may fail to start up altogether. It is also possible to quote $C_{L}$ to the crystal manufacturer who can then cut a crystal to order which will resonate, under the specified load conditions, at the desired frequency.

Finally the power dissipation in the crystal must be checked. If Pc is too high C 1 and C 2 must be reduced. If this is not feasible C2 alone may be reduced. Unbalancing C1 and C2 will, however, require checking if the loop gain condition is still satisfied. This must be done using Equation 1.
Note: $2 \geq \frac{\mathrm{C}_{2}}{\mathrm{C}_{1}} \geq 0.5$

### 5.4.1.5 Oscillator/Clock Application Notes

- On the printed circuit board, the tracks to the crystal and capacitors must be made as short as possible. Other signal tracks must not be allowed to cross through this area. The component tracks should preferably be ringed by a ground track connected to the chip ground ( 0 V ) on adjacent pins either side of the crystal pins. It is also advisable to provide a ground plane for the circuit to reduce noise.
- External clock signals, applied to $\overline{\mathrm{XTI}}$ and/or XTO, must not exceed the cell supply limits (i.e., OV and CVDD) and current into or out of XTI and/or XTO must be limited to less than 10 mA to avoid damaging the cell's amplitude clamping circuit.
- An external, DC coupled, single ended square wave clock signal may be applied to $\overline{\mathrm{XTI}}$ if $\mathrm{OSCMODE}=0$. To limit the current taken from the signal source a resistor should be placed between the clock source and XTI. The recommended value for this series resistor is $470 \Omega$ for a clock signal switching between 0 V and CVDD. The current the clock source needs to source/sink is then $\leq 1.9 \mathrm{~mA}$. The XTO pin must be left unconnected in this configuration.
- AC coupling of a single ended external clock to $\overline{\mathrm{XTI}}$, with OSCMODE $=0$, is not recommended. The duty cycle of the OSCOUT signal cannot be guaranteed in such a configuration.
- AC coupling of a single ended external clock to $\overline{\mathrm{XTI}}$, with $\operatorname{OSCMODE}=1$, is possible. It is recommended that the circuit shown in Figure 15 be used to correctly bias the oscillator inputs: The common-mode voltage VCM for $\overline{\mathrm{XTI}}$ and XTO, (set by the $36 \mathrm{k} \Omega$ and $22 \mathrm{k} \Omega$ resistors) must be 800 mV < VCM < CVDD and the amplitude Vpp of the clock signal must be $>100 \mathrm{mV}$.


Figure 15 - External Clocking via AC Coupling

- External, differential clock signals may be applied to $\overline{\mathrm{XTI}}$ and XTO if OSCMODE $=1$. The common-mode voltage VCM for the differential clock signals must be 800 mV < VCM < CVDD, and the peak-to-peak signal amplitude Vpp must be $>100 \mathrm{mV}$. It is recommended that differential clock signals have VCM $=1.0 \mathrm{~V}$. For Vpp $>400 \mathrm{mV}$ a resistor of $\geq 390 \Omega$ in series with XTI or XTO may be required to limit the current taken from or supplied to the clock sources.


### 6.0 Application Circuit



Figure 16 - Typical Application Circuit


## For more information about all Zarlink products visit our Web Site at

 www.zarlink.comInformation relating to products and services furnished herein by Zarlink Semiconductor Inc. or its subsidiaries (collectively "Zarlink") is believed to be reliable. However, Zarlink assumes no liability for errors that may appear in this publication, or for liability otherwise arising from the application or use of any such information, product or service or for any infringement of patents or other intellectual property rights owned by third parties which may result from such application or use. Neither the supply of such information or purchase of product or service conveys any license, either express or implied, under patents or other intellectual property rights owned by Zarlink or licensed from third parties by Zarlink, whatsoever. Purchasers of products are also hereby notified that the use of product in certain ways or in combination with Zarlink, or non-Zarlink furnished goods or services may infringe patents or other intellectual property rights owned by Zarlink.

This publication is issued to provide information only and (unless agreed by Zarlink in writing) may not be used, applied or reproduced for any purpose nor form part of any order or contract nor to be regarded as a representation relating to the products or services concerned. The products, their specifications, services and other information appearing in this publication are subject to change by Zarlink without notice. No warranty or guarantee express or implied is made regarding the capability, performance or suitability of any product or service. Information concerning possible methods of use is provided as a guide only and does not constitute any guarantee that such methods of use will be satisfactory in a specific piece of equipment. It is the user's responsibility to fully determine the performance and suitability of any equipment using such information and to ensure that any publication or data used is up to date and has not been superseded. Manufacturing does not necessarily include testing of all functions or parameters. These products are not suitable for use in any medical products whose failure to perform may result in significant injury or death to the user. All products and materials are sold and services provided subject to Zarlink's conditions of sale which are available on request.

Purchase of Zarlink's $I^{2} \mathrm{C}$ components conveys a licence under the Philips $\mathrm{I}^{2} \mathrm{C}$ Patent rights to use these components in and $\mathrm{I}^{2} \mathrm{C}$ System, provided that the system conforms to the $\mathrm{I}^{2} \mathrm{C}$ Standard Specification as defined by Philips.

Zarlink, ZL and the Zarlink Semiconductor logo are trademarks of Zarlink Semiconductor Inc.
Copyright Zarlink Semiconductor Inc. All Rights Reserved.

